

NEW!
Two & Three
Section Models

MMIC

REFLECTIONLESS FILTERS

50Ω DC to 21 GHz

The Big Deal

- High Stopband rejection, up to 50 dB
- Patented design terminates stopband signals
- Pass band cut-off up to 11 GHz
- Stop band up to 26 GHz
- Excellent repeatability through IPD* process



X-Series

Available in Low Pass
& High Pass designs

Product Overview

Mini-Circuits' **X-Series** of reflectionless filters now includes 2- and 3-section models, giving you ultra-high rejection in the stopband – up to 50 dB! Reflectionless filters employ a patented filter topology which absorbs and terminates stopband signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stopband, sending signals back to the source at 100% power. These reflections interact with neighboring components and often result in intermodulation and other interferences. By eliminating stopband reflections, reflectionless filters can readily be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

Key Features

Advantages

Easy integration with sensitive reflective components, e.g. mixers, multipliers	Reflectionless filters absorb unwanted signals falling in filter stopband, preventing reflections back to the source. This reduces generation of additional unwanted signals without the need for extra components like attenuators, improving system dynamic range and saving board space.
High stopband rejection, up to 50 dB	Ideal for applications where suppression of strong spurious signals and intermodulation products is needed.
Enables stable integration of wideband amplifiers	Because reflectionless filters maintain good impedance in the stopband; they can be integrated with high gain, wideband amplifiers without the risk of creating instabilities in these out of band regions.
Cascadable	Reflectionless filters can be cascaded in multiple sections to provide sharper and higher attenuation, while also preventing any standing waves that could affect passband signals. Low & highpass filters can be cascaded to realize bandpass filters.
Excellent power handling in a tiny surface mount device up to 7W in passband	High power handling extends the usability of these filters to the transmit path for inter-stage filtering.
Small size, 3x3mm/ 4x4 mm/ 5x5mm QFN	Allows replacement of filter/attenuator pairs with a single reflectionless filter, saving board space.
Excellent repeatability of RF performance	Through semiconductor IPD process, X-series filters are inherently repeatable for large volume production.
Excellent stability over temperature	With ± 0.3 dB variation over temperature ideal for use in wide temperature range applications without the need for additional temperature compensation.
Operating temperature up to 105°C	Suitable for operation close to high power components.

*IPD – Integrated Passive Device, is a GaAs semiconductor process



XHF-721M+

Features

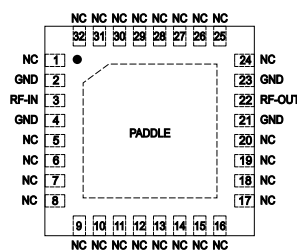
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+RoHS Compliant

Applications

- ## General Description

simplified schematic and pad description



Function	Pad Number	Description
RF-IN	3	RF Input Pad
RF-OUT	22	RF Output Pad
GND	2,4,21,23	Connected to ground
NC (GND Externally)	1,5-20,24-32 & paddle	No internal connection

Electrical Specifications¹ at 25°C

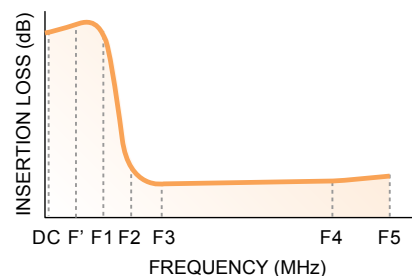
Parameter	F#	Frequency (MHz)	Min.	Typ.	Max.	Unit
Stop Band	Rejection	DC - F'	28	35	—	dB
		F' - F1	17	30	—	
	Frequency Cut-off	F2	—	3.0	—	:1
	VSWR	DC - F1	—	1.4	—	
Pass Band	Insertion Loss	F3 - F5	—	0.7	2.3	dB
		F3 - F4	—	1.1	—	
	VSWR	F4 - F5	—	1.7	—	:1

¹ Measured on Mini-Circuits Characterization Test Board TB-944-721M+Absolute Maximum Ratings⁴

Parameter	Ratings
Operating Temperature	-55°C to +105°C
Storage Temperature	-65°C to +150°C
RF Power Input, Passband (F3-F5) ²	32 dBm at 25°C
RF Power Input, Stopband (DC-F3) ³	35 dBm at 25°C

² Passband rating derates linearly to 29 dBm at 105°C ambient³ Stopband rating derates linearly to 32 dBm at 105°C ambient⁴ Permanent damage may occur if any of these limits are exceeded.

SPECIFICATION DEFINITION

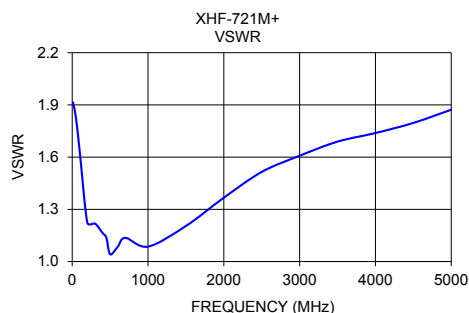
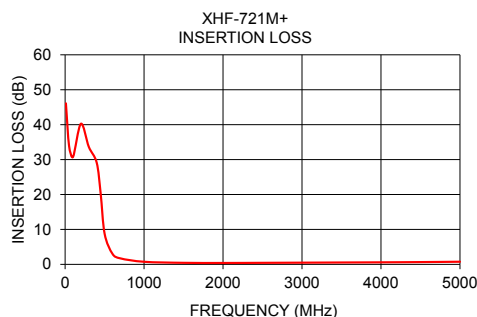


ESD rating

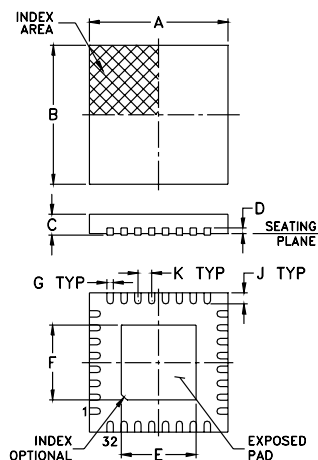
Human body model (HBM): Class 2(Pass 2000V) in accordance with ANSI/ESD 5.1-2001

Typical Performance Data at 25°C

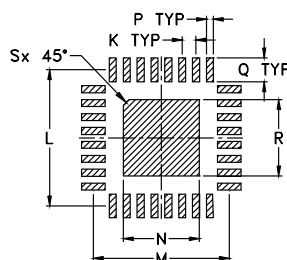
Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)
10	46.11	1.91
50	33.91	1.82
100	30.74	1.63
200	40.26	1.22
300	33.64	1.22
400	29.11	1.16
450	20.33	1.14
500	8.78	1.04
600	3.01	1.08
700	1.71	1.14
1000	0.74	1.09
1500	0.44	1.20
2000	0.40	1.37
2500	0.44	1.51
3000	0.49	1.61
3500	0.54	1.69
4000	0.58	1.74
4500	0.65	1.80
5000	0.75	1.87



Outline Drawing

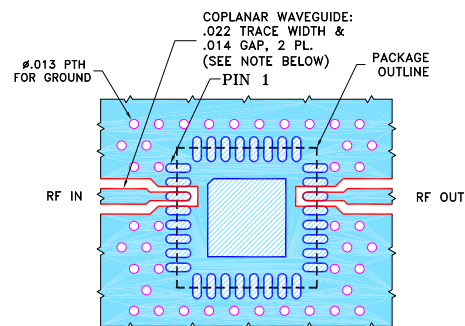


PCB Land Pattern



Suggested Layout,
Tolerance to be within ± 0.002

Demo Board MCL P/N: TB-944-721M+
Suggested PCB Layout: PL-518



NOTES:

1. TRACE WIDTH & GAP ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS $.010" \pm .001"$; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

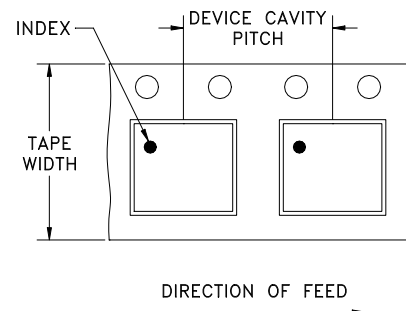
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Outline Dimensions ($\frac{\text{inch}}{\text{mm}}$)

A	B	C MAX	C MIN	D	E	F	G	H	J
.197	.197	.039	.031	.008	.142	.142	.009	-	.016
5.00	5.00	0.99	0.79	0.20	3.61	3.61	0.23	-	0.41
K	L	M	N	P	Q	R	S	wt	
.020	.193	.193	.110	.012	.035	.110	0.008	grams	
0.51	4.90	4.90	2.79	0.30	0.89	2.79	0.20	0.05	

Tape & Reel Packaging, F68

DEVICE ORIENTATION IN T&R



Product Marking



black body

model family designation

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note
12	8	7	20
			50
			100
			200
			500
		7	Standard 1000
		13	Standard 2000
			Standard 3000
			Standard 4000

Lead Finish: Matte-Tin

Application Circuit Example

Pairing mixers with reflectionless filters to improve system dynamic range



Test block diagram: IF output reflection spectrum with single input frequency



Figure 1. IF output reflection spectrum without filter



Figure 2. IF output reflection spectrum with conventional filter

An application circuit was assembled to measure the IF reflection spectrum at the output of a mixer when the mixer was paired with a conventional filter versus a reflectionless filter.

While the conventional filter reduces the reflections present when the mixer is used alone (no filter), the reflectionless filter virtually eliminates those reflections altogether.

The reflected signal at marker 1 in the figures above exhibits a reduction of more than 20 dB from -28.7 dBm to -50.3 dBm when the reflectionless filter is used as compared to the conventional filter, thus eliminating unwanted spurious mixing products and improving system dynamic range.

For more information, refer to application note [AN-75-007](#)



Figure 3. IF output reflection spectrum with reflectionless filter

Additional Notes

- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

